

addition, Patentee believes that the change to the chemical formula presents a narrowing of the claim because in the corrected structure additional atoms are included in the chemical formula.

Patentee does not believe the present reissue application is a broadening reissue application. However, Patentee recognizes that a third party might maintain the amendment submitted herein represents a broadening of the claims. To the extent a third party might so maintain, and should the Office or a competent court so decide, this application is timely filed for such broadening reissue.

A Request for Petition for Certificate of Correction to be decided by Supervisory Examiner is pending before the Patent Office on the above identified patent. The Request, submitted September 17, 2002, addresses the same issue that is presented in this reissue application and seeks a supervisory examiner decision relating to a Request for Certificate of Correction. If the Certificate of Correction is granted, the present reissue application will be rendered moot.

REISSUE AMENDMENTS

IN THE SPECIFICATION:

Please delete in its entirety the paragraph beginning at Column 2, line 66 and ending at Column 3, line 18, and replace it with the following paragraph:

In one embodiment the difunctional epoxy resin (B-1) is a compound represented by the formula:

